## feATURES

- 73.4dB SNR
- 85dB SFDR
- Low Power: $127 \mathrm{~mW} / 106 \mathrm{~mW} / 89 \mathrm{~mW}$
- Single 1.8 V Supply
- CMOS, DDR CMOS or DDR LVDS Outputs
- Selectable Input Ranges: $1 \mathrm{~V}_{\text {P-p }}$ to $2 \mathrm{~V}_{\text {P-p }}$
- 800MHz Full-Power Bandwidth S/H
- Optional Data Output Randomizer
- Optional Clock Duty Cycle Stabilizer
- Shutdown and Nap Modes
- Serial SPI Port for Configuration
- Pin Compatible 14-Bit and 12-Bit Versions
- 40 -Pin ( $6 \mathrm{~mm} \times 6 \mathrm{~mm}$ ) QFN Package


## APPLICATIONS

- Communications
- Cellular Base Stations
- Software Defined Radios
- Portable Medical Imaging
- Multi-Channel Data Acquisition
- Nondestructive Testing


## DESCRIPTIOn

The LTC ${ }^{\circledR} 2261-14 / L T C 2260-14 / L T C 2259-14$ are sampling 14-bit A/D converters designed for digitizing high frequency, wide dynamic range signals. They are perfect for demanding communications applications with AC performance that includes 73.4 dB SNR and 85 dB spurious free dynamic range (SFDR). Ultralow jitter of 0.17 ps $_{\text {RMS }}$ allows undersampling of IF frequencies with excellent noise performance.
DC specs include $\pm 1$ LSB INL (typical), $\pm 0.3$ SSB DNL (typical) and no missing codes overtemperature. The transition noise is a low 1.2 LSB RMs .
The digital outputs can be either full-rate CMOS, doubledata rate CMOS, or double-data rate LVDS. A separate output power supply allows the CMOS output swing to range from 1.2 V to 1.8 V .
The ENC ${ }^{+}$and ENC ${ }^{-}$inputs may be driven differentially or single ended with a sine wave, PECL, LVDS, TL or CMOS inputs. An optional clock duty cycle stabilizer allows high performance at full speed for a wide range of clock duty cycles.
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## TYPICAL APPLICATION



2-Tone FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ and 75 MHz


## ABSOLUTE MAXIMUUM RATINGS (Notes 1,2 )

| Supply Voltages ( $\mathrm{V}_{\mathrm{DD}}, \mathrm{O} \mathrm{V}_{\mathrm{DD}}$ )................... -0.3 V to 2 V | Dig |
| :---: | :---: |
| Analog Input Voltage ( $\mathrm{AIN}^{+}, \mathrm{A}_{\text {IN }}{ }^{-}$, | Operating Temperature Range: |
| PAR/SER, SENSE) (Note 3).........-0.3V to ( $\mathrm{V}_{\mathrm{DD}}+0.2 \mathrm{~V}$ ) | LTC2261C, LTC2260C, LTC2259C........... $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Digital Input Voltage (ENC+, ENC${ }^{-}$, $\overline{\mathrm{SS}}$, | LTC22611, LTC22601, LTC22591 .......... $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| SDI, SCK) (Note 4)............................-0.3V to 3.9V | Storage Temperature Range ................ $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| 0 (Note 4)....................................-0.3V to 3.9V |  |

## PIn CONFIGURATIONS




40-LEAD ( $6 \mathrm{~mm} \times 6 \mathrm{~mm}$ ) PLASTIC QFN
$\mathrm{T}_{\mathrm{JMAX}}=150^{\circ} \mathrm{C}, \theta_{\mathrm{JA}}=32^{\circ} \mathrm{C} / \mathrm{W}$
EXPOSED PAD (PIN 41) IS GND, MUST BE SOLDERED TO PCB

|  | DOUBLE DATA RATE LVDS OUTPUT MODE TOP VIEW |  |
| :---: | :---: | :---: |
|  |  |  |
|  |  |  |
| $\mathrm{AlN}^{+}$ | -1] | D8_9 ${ }^{+}$ |
| $\mathrm{AlN}^{-}$ | 2] -------------- | D8_9 ${ }^{-}$ |
| GND | -3] | CLKOUT ${ }^{+}$ |
| REFH | - 4 - | CLKOUT ${ }^{-}$ |
| REFH | [5] \| 41 |l|l | OV ${ }_{\text {D }}$ |
| REFL | - ${ }^{\text {6! }}$ GND | OGND |
| REFL | -7! | D6_7 ${ }^{+}$ |
| PAR/ $\overline{S E R}$ |  | D6_7 ${ }^{-}$ |
| $V_{\text {DD }}$ | 9] - - | D4_5 ${ }^{+}$ |
| $V_{\text {DD }}$ | 10] | D4_5 |
|  |  |  |
|  <br> UJ PACKAGE <br> 40-LEAD $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ PLASTIC QFN |  |  |
|  | $\begin{gathered} \mathrm{T}_{\mathrm{JMAX}}=150^{\circ} \mathrm{C}, \theta_{\mathrm{JA}}=32^{\circ} \mathrm{C} / \mathrm{W} \\ \text { OSED PAD (PIN 41) IS GND, MUST BE SOLDERED TC } \end{gathered}$ | $0 \text { PCB }$ |

## ORDER INFORMATION

| LEAD FREE FINISH | TAPE AND REEL | PART MARKING* | PACKAGE DESCRIPTION | TEMPERATURE RANGE |
| :--- | :--- | :--- | :--- | :--- |
| LTC2261CUJ-14\#PBF | LTC2261CUJ-14\#TRPBF | LTC2261UJ-14 | $40-$ Lead $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ Plastic QFN | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| LTC2261IUJ-14\#PBF | LTC2261IUJ-14\#TRPBF | LTC2261UJ-14 | $40-$ Lead $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTC2260CUJ-14\#PBF | LTC2260CUJ-14\#TRPBF | LTC2260UJ-14 | $40-$ Lead $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ Plastic QFN | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| LTC2260IUJ-14\#PBF | LTC2260IUJ-14\#TRPBF | LTC2260UJ-14 | $40-$ Lead $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| LTC2259CUJ-14\#PBF | LTC2259CUJ-14\#TRPBF | LTC2259UJ-14 | $40-$ Lead $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ Plastic QFN | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| LTC2259IUJ-14\#PBF | LTC2259IUJ-14\#TRPBF | LTC2259UJ-14 | $40-$ Lead $(6 \mathrm{~mm} \times 6 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.
Consult LTC Marketing for information on non-standard lead based finish parts.
For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

## COПVERTER CHARACTERISTICS The • denotes the specifications which apply over the full operating

temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| PARAMETER | CONDITIONS |  | LTC2261-14 |  |  | LTC2260-14 |  |  | LTC2259-14 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Resolution (No Missing Codes) |  | $\bullet$ | 14 |  |  | 14 |  |  | 14 |  |  | Bits |
| Integral Linearity Error | Differential Analog Input (Note 6) | $\bullet$ | -3.75 | $\pm 1$ | 3.75 | -3.75 | $\pm 1$ | 3.75 | -3.5 | $\pm 1$ | 3.5 | LSB |
| Differential Linearity Error | Differential Analog Input | $\bullet$ | -0.9 | $\pm 0.3$ | 0.9 | -0.9 | $\pm 0.3$ | 0.9 | -0.9 | $\pm 0.3$ | 0.9 | LSB |
| Offset Error | (Note 7) | $\bullet$ | -9 | $\pm 1.5$ | 9 | -9 | $\pm 1.5$ | 9 | -9 | $\pm 1.5$ | 9 | mV |
| Gain Error | Internal Reference External Reference | $\bullet$ | -1.5 | $\begin{aligned} & \pm 1.5 \\ & \pm 0.4 \end{aligned}$ | 1.5 | -1.5 | $\begin{aligned} & \pm 1.5 \\ & \pm 0.4 \end{aligned}$ | 1.5 | -1.5 | $\begin{aligned} & \pm 1.5 \\ & \pm 0.4 \end{aligned}$ | 1.5 | $\begin{aligned} & \hline \% \text { FS } \\ & \% \text { FS } \end{aligned}$ |
| Offset Drift |  |  |  | $\pm 20$ |  |  | $\pm 20$ |  |  | $\pm 20$ |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Full-Scale Drift | Internal Reference External Reference |  |  | $\begin{aligned} & \pm 30 \\ & \pm 10 \end{aligned}$ |  |  | $\begin{aligned} & \pm 30 \\ & \pm 10 \end{aligned}$ |  |  | $\begin{aligned} & \pm 30 \\ & \pm 10 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| Transition Noise | External Reference |  |  | 1.2 |  |  | 1.2 |  |  | 1.2 |  | $L^{\text {LSB }}$ RMS |

LTC2261-14
LTC2260-14/LTC2259-14
ANALOG INPUT
The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise
specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VIN | Analog Input Range ( $\left.\mathrm{AIN}^{+}-\mathrm{AIN}^{-}\right)$ | $1.7 \mathrm{~V}<\mathrm{V}_{\mathrm{DD}}<1.9 \mathrm{~V}$ | $\bullet$ |  | 1 to 2 |  | $\mathrm{V}_{\mathrm{P}-\mathrm{P}}$ |
| $\mathrm{V}_{\text {IN(CM) }}$ | Analog Input Common Mode ( $\left.\mathrm{AIN}^{+}+\mathrm{A}_{\text {IN }}^{-}\right) / 2$ | Differential Analog Input (Note 8) | - | $\mathrm{V}_{\text {CM }}-100 \mathrm{mV}$ | $\mathrm{V}_{\text {CM }}$ | $\mathrm{V}_{\text {CM }}+100 \mathrm{mV}$ | V |
| $\mathrm{V}_{\text {SENSE }}$ | External Voltage Reference Applied to SENSE | External Reference Mode | $\bullet$ | 0.625 | 1.250 | 1.300 | V |
| IINCM | Analog Input Common Mode Current | Per Pin, 125Msps Per Pin, 105Msps Per Pin, 80Msps |  |  | $\begin{aligned} & \hline 155 \\ & 130 \\ & 100 \end{aligned}$ |  | $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $\underline{1 / 15}$ | Analog Input Leakage Current | $0<\mathrm{A}_{\text {IN }}+$, $\mathrm{AIN}^{-}<\mathrm{V}_{\text {DD }}$, No Encode | $\bullet$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| $1{ }^{1 \times 2}$ | PAR/ $\overline{\text { SER }}$ Input Leakage Current | $0<\mathrm{PAR} / \overline{\mathrm{SER}}<\mathrm{V}_{\mathrm{DD}}$ | $\bullet$ | -3 |  | 3 | $\mu \mathrm{A}$ |
| $1{ }_{\text {IN3 }}$ | SENSE Input Leakage Current | 0.625 < SENSE < 1.3 V | $\bullet$ | -6 |  | 6 | $\mu \mathrm{A}$ |
| $\mathrm{t}_{\text {AP }}$ | Sample-and-Hold Acquisition Delay Time |  |  |  | 0 |  | ns |
| $\mathrm{t}_{\text {JITER }}$ | Sample-and-Hold Acquisition Delay Jitter |  |  |  | 0.17 |  | $\mathrm{PS}_{\text {RMS }}$ |
| CMRR | Analog Input Common Mode Rejection Ratio |  |  |  | 80 |  | dB |
| BW-3B | Full-Power Bandwidth | Figure 6 Test Circuit |  |  | 800 |  | MHz |

РYПค円П|С ACCURACY The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. $\mathrm{A}_{\mathrm{IN}}=-1 \mathrm{dBFS}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS |  | LTC2261-14 |  |  | LTC2260-14 |  |  | LTC2259-14 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| SNR | Signal-to-Noise Ratio | 5MHz Input 70MHz Input 140MHz Input | $\bullet$ | 71.3 | $\begin{aligned} & 73.4 \\ & 73.2 \\ & 72.7 \end{aligned}$ |  | 71.3 | $\begin{aligned} & 73.4 \\ & 73.2 \\ & 72.7 \end{aligned}$ |  | 70.9 | $\begin{aligned} & \hline 73.1 \\ & 72.9 \\ & 72.4 \end{aligned}$ |  | dB dB dB |
| $\overline{\text { SFDR }}$ | Spurious Free Dynamic Range 2nd or 3rd Harmonic | 5MHz Input 70MHz Input 140MHz Input | $\bullet$ | 76 | $\begin{aligned} & \hline 88 \\ & 85 \\ & 82 \end{aligned}$ |  | 76 | $\begin{aligned} & \hline 88 \\ & 85 \\ & 82 \end{aligned}$ |  | 79 | $\begin{aligned} & 88 \\ & 85 \\ & 82 \end{aligned}$ |  | dB dB dB |
|  | Spurious Free Dynamic Range 4th Harmonic or Higher | 5MHz Input 70MHz Input 140MHz Input | $\bullet$ | 85 | $\begin{aligned} & 90 \\ & 90 \\ & 90 \\ & \hline \end{aligned}$ |  | 83 | $\begin{aligned} & 90 \\ & 90 \\ & 90 \\ & \hline \end{aligned}$ |  | 85 | $\begin{aligned} & 90 \\ & 90 \\ & 90 \\ & \hline \end{aligned}$ |  | dB dB dB |
| S/(N+D) | Signal-to-Noise Plus Distortion Ratio | 5MHz Input 70MHz Input 140MHz Input | $\bullet$ | 70.2 | $\begin{gathered} \hline 73 \\ 72.6 \\ 72 \end{gathered}$ |  | 70.2 | $\begin{gathered} \hline 73 \\ 72.6 \\ 72 \end{gathered}$ |  | 70.4 | $\begin{gathered} 72.9 \\ 72.6 \\ 72 \end{gathered}$ |  | dB dB dB |

IMTR円คL REFERENCE CHPRACTERISTCS The o denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {CM }}$ Output Voltage | $\mathrm{I}_{\text {OUT }}=0$ | $0.5 \cdot \mathrm{~V}_{\mathrm{DD}}-25 \mathrm{mV}$ | $0.5 \cdot \mathrm{~V}_{\mathrm{DD}}$ | $0.5 \cdot \mathrm{~V}_{\mathrm{DD}}+25 \mathrm{mV}$ | V |
| $\mathrm{V}_{\text {CM }}$ Output Temperature Drift |  |  | $\pm 25$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\text {CM }}$ Output Resistance | $-600 \mu \mathrm{~A}$ < $\mathrm{I}_{\text {OUT }}<1 \mathrm{~mA}$ |  | 4 |  | $\Omega$ |
| $\mathrm{V}_{\text {REF }}$ Output Voltage | $\mathrm{I}_{\text {OUT }}=0$ | 1.225 | 1.250 | 1.275 | $V$ |
| $\mathrm{V}_{\text {REF }}$ Output Temperature Drift |  |  | $\pm 25$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\text {REF }}$ Output Resistance | $-400 \mu \mathrm{~A}<\mathrm{I}_{\text {OUT }}<1 \mathrm{~mA}$ |  | 7 |  | $\Omega$ |
| $\mathrm{V}_{\text {REF }}$ Line Regulation | $1.7 \mathrm{~V}<\mathrm{V}_{\mathrm{DD}}<1.9 \mathrm{~V}$ |  | 0.6 |  | $\mathrm{mV} / \mathrm{V}$ |

DIGITAL IIPUTS AחD OUTPUTS The e denotes the specifications which apply over the tull operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX |
| :--- | :--- | :--- | :--- | :--- | :---: |
| UNITS |  |  |  |  |  |
| ENCODE INPUTS (ENC ${ }^{+}$, ENC |  |  |  |  |  |
| Differential | Encode Mode (ENC |  |  |  |  |

Single-Ended Encode Mode (ENC- Tied to GND)

| $V_{I H}$ | High Level Input Voltage | $V_{D D}=1.8 \mathrm{~V}$ | $\bullet$ | 1.2 | V |
| :--- | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low Level Input Voltage | $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}$ | $\bullet$ | 0.6 | V |
| $\mathrm{~V}_{\mathrm{IN}}$ | Input Voltage Range | ENC + to GND | $\bullet$ | 0 | 3.6 |
| $\mathrm{R}_{\mathrm{IN}}$ | Input Resistance | (See Figure 11) |  | V |  |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance | (Note 8) |  | 30 | $\mathrm{k} \Omega$ |

## DIGITAL INPUTS ( $\overline{\mathbf{C S}}$, SDI, SCK)

| $V_{\text {IH }}$ | High Level Input Voltage | $V_{D D}=1.8 \mathrm{~V}$ | $\bullet$ | 1.3 | V |
| :--- | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low Level Input Voltage | $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}$ | $\bullet$ |  | 0.6 |
| $\mathrm{I}_{\text {IN }}$ | Input Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to 3.6V | $\bullet$ | -10 | 10 |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance | (Note 8) |  | VA |  |

## SDO OUTPUT (Open-Drain Output. Requires 2k Pull-Up Resistor if SDO is Used)

| $\mathrm{R}_{\text {OL }}$ | Logic Low Output Resistance to GND | $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}, \mathrm{SDO}=0 \mathrm{~V}$ |  | 200 |  |
| :--- | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{IOH}_{\text {OH }}$ | Logic High Output Leakage Current | $\mathrm{SDO}=0 \mathrm{~V}$ to 3.6 V | $\bullet$ | -10 | $\mu \mathrm{~A}$ |
| $\mathrm{C}_{\text {OUT }}$ | Output Capacitance | (Note 8) |  | 4 | pF |

## DIGITAL DATA OUTPUTS (CMOS MODES: FULL DATA RATE AND DOUBLE-DATA RATE)

$\mathrm{OV}_{\mathrm{DD}}=1.8 \mathrm{~V}$

| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $\mathrm{I}_{0}=-500 \mu \mathrm{~A}$ | $\bullet$ | 1.750 | 1.790 | V |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low Level Output Voltage | $\mathrm{I}_{0}=500 \mu \mathrm{~A}$ | $\bullet$ | 0.010 | 0.050 | V |

## $0 V_{D D}=1.5 \mathrm{~V}$

| $V_{O H}$ | High Level Output Voltage | $\mathrm{I}_{0}=-500 \mu \mathrm{~A}$ | 1.488 | V |
| :--- | :--- | :--- | :--- | :---: |
| $\mathrm{~V}_{0 \mathrm{~L}}$ | Low Level Output Voltage | $\mathrm{I}_{0}=500 \mu \mathrm{~A}$ | 0.010 | V |

## $0 V_{D D}=1.2 \mathrm{~V}$

| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $\mathrm{I}_{0}=-500 \mu \mathrm{~A}$ | 1.185 | V |
| :--- | :--- | :--- | :--- | :---: |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low Level Output Voltage | $\mathrm{I}_{0}=500 \mu \mathrm{~A}$ | 0.010 | V |

DIGITAL DATA OUTPUTS (LVDS MODE)
$\left.\begin{array}{l|l|l|l|lc|c}\hline V_{O D} & \text { Differential Output Voltage } & 100 \Omega \text { Differential Load, } 3.5 \mathrm{~mA} \text { Mode } & \bullet & 247 & 350 & 454 \\ & & 100 \Omega \text { Differential Load, } 1.75 \mathrm{~mA} \text { Mode }\end{array}\right)$

POUER REQUREME円TS The o denotes the specifications which apply over the full operating temperature
range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 9)

| SYMBOL | PARAMETER | CONDITIONS |  | LTC2261-14 |  |  | LTC2260-14 |  |  | LTC2259-14 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| CMOS Output Modes: Full Data Rate and Double-Data Rate |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{DD}}$ | Analog Supply Voltage | (Note 10) | $\bullet$ | 1.7 | 1.8 | 1.9 | 1.7 | 1.8 | 1.9 | 1.7 | 1.8 | 1.9 | V |
| $\underline{O V D}$ | Output Supply Voltage | (Note 10) | $\bullet$ | 1.1 |  | 1.9 | 1.1 |  | 1.9 | 1.1 |  | 1.9 | V |
| $l_{\text {VDD }}$ | Analog Supply Current | DC Input Sine Wave Input | $\bullet$ |  | $\begin{aligned} & \hline 70.5 \\ & 71.8 \end{aligned}$ | 83.2 |  | $\begin{aligned} & \hline 58.6 \\ & 59.8 \end{aligned}$ | 69.1 |  | $\begin{aligned} & 49.2 \\ & 50.2 \end{aligned}$ | 58.1 | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| Iovdd | Digital Supply Current | Sine Wave Input, $\mathrm{OV}_{\mathrm{DD}}=1.2 \mathrm{~V}$ |  |  | 3.9 |  |  | 3.3 |  |  | 2.5 |  | mA |
| $\mathrm{P}_{\text {DISS }}$ | Power Dissipation | DC Input Sine Wave Input, $\mathrm{OV}_{\mathrm{DD}}=1.2 \mathrm{~V}$ | $\bullet$ |  | $\begin{aligned} & 127 \\ & 134 \end{aligned}$ | 150 |  | $\begin{aligned} & 106 \\ & 112 \end{aligned}$ | 125 |  | $\begin{aligned} & 89 \\ & 93 \end{aligned}$ | 105 | $\begin{aligned} & \mathrm{mW} \\ & \mathrm{~mW} \end{aligned}$ |

## LVDS Output Mode

| $\mathrm{V}_{\mathrm{DD}}$ | Analog Supply Voltage | (Note 10) | $\bullet$ | 1.7 | 1.8 | 1.9 | 1.7 | 1.8 | 1.9 | 1.7 | 1.8 | 1.9 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\underline{O V_{D D}}$ | Output Supply Voltage | (Note 10) | $\bullet$ | 1.7 |  | 1.9 | 1.7 |  | 1.9 | 1.7 |  | 1.9 | V |
| $\mathrm{I}_{\text {VDD }}$ | Analog Supply Current | Sine Wave Input | $\bullet$ |  | 75.4 | 89 |  | 63.4 | 74.8 |  | 53.8 | 63.5 | mA |
| IOVDD | Digital Supply Current $\left(0 V_{D D}=1.8 \mathrm{~V}\right)$ | Sine Input, 1.75 mA Mode Sine Input, 3.5mA Mode | $\bullet$ |  | $\begin{aligned} & 20.7 \\ & 40.5 \end{aligned}$ | $\begin{gathered} \hline 26 \\ 47.8 \end{gathered}$ |  | $\begin{aligned} & 20.7 \\ & 40.5 \end{aligned}$ | $\begin{gathered} 26 \\ 47.8 \end{gathered}$ |  | $\begin{aligned} & 20.7 \\ & 40.5 \end{aligned}$ | $\begin{gathered} \hline 26 \\ 47.8 \end{gathered}$ | mA mA |
| $\mathrm{P}_{\text {DISS }}$ | Power Dissipation | Sine Input, 1.75 mA Mode Sine Input, 3.5mA Mode | $\bullet$ |  | $\begin{aligned} & \hline 173 \\ & 209 \end{aligned}$ | $\begin{aligned} & 207 \\ & 246 \end{aligned}$ |  | $\begin{aligned} & 151 \\ & 187 \end{aligned}$ | $\begin{aligned} & 182 \\ & 221 \end{aligned}$ |  | $\begin{aligned} & \hline 134 \\ & 170 \end{aligned}$ | $\begin{aligned} & 161 \\ & 201 \end{aligned}$ | mW mW |

## All Output Modes

| $\mathrm{P}_{\text {SLEEP }}$ | Sleep Mode Power |  | 0.5 | 0.5 | 0.5 | mW |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{P}_{\text {NAP }}$ | Nap Mode Power |  | 9 | 9 | 9 | mW |
| $P_{\text {DIFFCLK }}$ | Power Increase with Differential Encode Mode Enabled <br> (No increase for Nap or Sleep Modes) | 10 | 10 | 10 | mW |  |

TMIAC CHARACTERISTICS The © denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS |  | LTC2261-14 |  |  | LTC2260-14 |  |  | LTC2259-14 |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| $\mathrm{f}_{\text {S }}$ | Sampling Frequency | (Note 10) | $\bullet$ | 1 |  | 125 | 1 |  | 105 | 1 |  | 80 | MHz |
| $t_{L}$ | ENC Low Time (Note 8) | Duty Cycle Stabilizer Off Duty Cycle Stabilizer On | $0$ | $\begin{aligned} & \hline 3.8 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \hline 4 \\ & 4 \end{aligned}$ | $\begin{aligned} & \hline 500 \\ & 500 \end{aligned}$ | $\begin{aligned} & 4.52 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 4.76 \\ & 4.76 \end{aligned}$ | $\begin{aligned} & 500 \\ & 500 \end{aligned}$ | $\begin{aligned} & \hline 5.93 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 6.25 \\ & 6.25 \end{aligned}$ | $\begin{aligned} & \hline 500 \\ & 500 \end{aligned}$ | ns |
| $\mathrm{th}^{\text {l }}$ | ENC High Time (Note 8) | Duty Cycle Stabilizer Off Duty Cycle Stabilizer On | $0$ | $\begin{aligned} & \hline 3.8 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4 \\ & 4 \end{aligned}$ | $\begin{aligned} & \hline 500 \\ & 500 \end{aligned}$ | $\begin{aligned} & 4.52 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 4.76 \\ & 4.76 \end{aligned}$ | $\begin{aligned} & 500 \\ & 500 \end{aligned}$ | $\begin{aligned} & 5.93 \\ & 2.00 \end{aligned}$ | $\begin{aligned} & 6.25 \\ & 6.25 \end{aligned}$ | $\begin{aligned} & 500 \\ & 500 \end{aligned}$ | ns |
| $\mathrm{t}_{\mathrm{AP}}$ | Sample-and-Hold Acquisition Delay Time |  |  |  | 0 |  |  | 0 |  |  | 0 |  | ns |


| SYMBOL | PARAMETER | CONDITIONS | MIN $\quad$ TYP | MAX | UNITS |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Digital Data Outputs (CMOS Modes: Full Data Rate and Double-Data Rate)

| $t_{D}$ | ENC to Data Delay | $C_{L}=5 p F$ (Note 8) | $\bullet$ | 1.1 | 1.7 | 3.1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: |
| $\mathrm{t}_{\mathrm{C}}$ | ENC to CLKOUT Delay | $\mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ (Note 8) | $\bullet$ | 1 | 1.4 | 2.6 |
| $\mathrm{t}_{\text {SKEW }}$ | DATA to CLKOUT Skew | $\mathrm{t}_{\mathrm{D}}-\mathrm{t}_{\mathrm{C}}$ (Note 8) | $\bullet$ | 0 | 0.3 | 0.6 |
|  | Pipeline Latency | Full Data Rate Mode |  |  | 5.0 | ns |
|  |  | Double-Data Rate Mode | 5.5 | Cycles |  |  |
|  |  |  |  |  | Cycles |  |

TIMInG CHARACTERISTICS The © denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5 )

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Digital Data Outputs (LVDS Mode) |  |  |  |  |  |  |  |
| $t_{D}$ | ENC to Data Delay | $C_{L}=5 \mathrm{pF}$ (Note 8) | $\bullet$ | 1.1 | 1.8 | 3.2 | ns |
| $\mathrm{t}_{\mathrm{C}}$ | ENC to CLKOUT Delay | $\mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ (Note 8) | $\bullet$ | 1 | 1.5 | 2.7 | ns |
| tSKEW | DATA to CLKOUT Skew | $\mathrm{t}_{\mathrm{D}}-\mathrm{t}_{\mathrm{C}}$ (Note 8) | $\bullet$ | 0 | 0.3 | 0.6 | ns |
|  | Pipeline Latency |  |  |  | 5.5 |  | Cycles |
| SPI Port Timing (Note 8) |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {SCK }}$ | SCK Period | Write Mode Readback Mode, CSDO $=20 \mathrm{pF}$, Rpullup $=2 \mathrm{k}$ |  | $\begin{gathered} 40 \\ 250 \end{gathered}$ |  |  | ns |
| ts | $\overline{\text { CS }}$ to SCK Setup Time |  | $\bullet$ | 5 |  |  | ns |
| $\mathrm{t}_{\mathrm{H}}$ | SCK to $\overline{\mathrm{CS}}$ Setup Time |  | $\bullet$ | 5 |  |  | ns |
| tDS | SDI Setup Time |  | $\bullet$ | 5 |  |  | ns |
| $t_{\text {DH }}$ | SDI Hold Time |  | $\bullet$ | 5 |  |  | ns |
| $\mathrm{t}_{\mathrm{DO}}$ | SCK Falling to SDO Valid | Readback Mode, $\mathrm{C}_{\text {SDO }}=20 \mathrm{pF}, \mathrm{R}_{\text {PULLUP }}=2 \mathrm{k}$ | $\bullet$ |  |  | 125 | ns |

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.
Note 2: All voltage values are with respect to GND with GND and OGND shorted (unless otherwise noted).
Note 3: When these pin voltages are taken below GND or above $\mathrm{V}_{\mathrm{DD}}$, they will be clamped by internal diodes. This product can handle input currents of greater than 100 mA below $G N D$ or above $V_{D D}$ without latchup.
Note 4: When these pin voltages are taken below GND they will be clamped by internal diodes. When these pin voltages are taken above $V_{D D}$ they will not be clamped by internal diodes. This product can handle input currents of greater than 100 mA below GND without latchup.
Note 5: $V_{D D}=0 V_{D D}=1.8 \mathrm{~V}, \mathrm{f}_{\text {SAMPLE }}=125 \mathrm{MHz}($ LTC2261 $)$, 105MHz (LTC2260), or 80MHz (LTC2259), LVDS outputs with internal
termination disabled, differential $\mathrm{ENC}^{+} /$ENC $^{-}=2 \mathrm{~V}_{\mathrm{P}-\mathrm{p}}$ sine wave, input range $=2 V_{p-p}$ with differential drive, unless otherwise noted
Note 6: Integral nonlinearity is defined as the deviation of a code from a best fit straight line to the transfer curve. The deviation is measured from the center of the quantization band.
Note 7: Offset error is the offset voltage measured from -0.5 LSB when the output code flickers between 00000000000000 and 1111111111 1111 in 2's complement output mode.
Note 8: Guaranteed by design, not subject to test.
Note 9: $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}$, $\mathrm{f}_{\text {SAMPLE }}=125 \mathrm{MHz}$ (LTC2261), 105MHz (LTC2260), or 80 MHz (LTC2259), $\mathrm{ENC}^{+}=$single-ended 1.8 V square wave, $\mathrm{ENC}^{-}=0 \mathrm{~V}$, input range $=2 \mathrm{~V}_{\text {P-p }}$ with differential drive, 5 pF load on each digital output unless otherwise noted.
Note 10: Recommended operating conditions.

Full-Rate CMOS Output Mode Timing All Outputs Are Single Ended and Have CMOS Levels


## tIMING DIAGRAMS

Double-Data Rate CMOS Output Mode Timing
All Outputs Are Single Ended and Have CMOS Levels


Double-Data Rate LVDS Output Mode Timing
All Outputs Are Differential and Have LVDS Levels


## timing diacrams

SPI Port Timing (Readback Mode)


SPI Port Timing (Write Mode)
CS

## TYPICAL PERFORMANCE CHARACTERISTICS




LTC2261-14: 8k Point FFT, $\mathrm{f}_{\mathrm{IN}}=5 \mathrm{MHz}$ -1dBFS, 125Msps


## TYPICAL PERFORMANCE CHARACTERISTICS

LTC2261-14: 8k Point FFT, $\mathrm{f}_{\mathrm{IN}}=30 \mathrm{MHz}$ -1dBFS, 125Msps


226114 G04
LTC2261-14: 8k Point 2-Tone FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}, 75 \mathrm{MHz},-1 \mathrm{dBFS}$, 125Msps


LTC2261-14: SFDR vs Input Frequency, -1dB, 2V Range, 125Msps


LTC2261-14: 8k Point FFT, $\mathfrak{f}_{\mathrm{I}}=70 \mathrm{MHz}$ -1dBFS, 125Msps


LTC2261-14: Shorted Input Histogram


226114 G08
LTC2261-14: SFDR vs Input Level, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$, 2V Range, 125Msps


LTC2261-14: 8k Point FFT, $\mathfrak{f}_{\mathrm{IN}}=140 \mathrm{MHz}$
-1dBFS, 125Msps


LTC2261-14: SNR vs Input
Frequency, -1dB, 2V Range, 125Msps


226114 G09
LTC2261-14: IvDD vs Sample Rate, 5 MHz Sine Wave Input, -1dB


226114 G13

226114 G10

## TYPICAL PERFORMANCE CHARACTERISTICS



LTC2261-14: 128k Point Averaged FFT, $\mathfrak{f}_{\mathrm{IN}}=70 \mathrm{MHz},-65 \mathrm{dBFS}, 125 \mathrm{Msps}$, RAND ON, ABP ON


226114G17
LTC2260-14: Differential Non-Linearity (DNL)


LTC2261-14: SNR vs SENSE, $\mathrm{f}_{\mathrm{IN}}=5 \mathrm{MHz},-1 \mathrm{~dB}$


LTC2261-14: SNR vs Sample Rate and Digital Output Mode, 30MHz Sine Wave Input, -1dB


LTC2260-14: 8k Point FFT, $f_{\text {IN }}=5 \mathrm{MHz}$ -1dBFS, 105Msps


LTC2261-14: 128k Point Averaged FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz},-65 \mathrm{dBFS}, 125 \mathrm{Msps}$, RAND OFF, ABP OFF


LTC2260-14: Integral Non-Linearity (INL)


226114 G21
LTC2260-14: 8k Point FFT, $\mathrm{f}_{\mathrm{I}}=30 \mathrm{MHz}$ -1dBFS, 105Msps


## TYPICAL PERFORMANCG CHARACTERISTICS

LTC2260-14: 8k Point FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ -1dBFS, 105Msps


226114 G25
LTC2260-14: Shorted Input Histogram


226114 G28
LTC2260-14: SFDR vs Input Level, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$, 2 V Range, 105Msps


LTC2260-14: $\mathbf{8 k}$ Point FFT, $\mathrm{f}_{\mathrm{IN}}=140 \mathrm{MHz}$ -1dBFS, 105Msps


LTC2260-14: SNR vs Input Frequency, -1dB, 2V Range, 105Msps


226114 G29
LTC2260-14: Ivod vs Sample Rate, 5MHz Sine Wave Input, -1dB


LTC2260-14: 8k Point 2-Tone FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}, 75 \mathrm{MHz},-1 \mathrm{dBFS}$, 105Msps


LTC2260-14: SFDR vs Input Frequency, -1dB, 2V Range, 105Msps


226114 G30
LTC2260-14: I OVDD vs Sample Rate, 5MHz Sine Wave Input, -1dB, 5pF on Each Data Output


## TYPICAL PERFORMANCE CHARACTERISTICS

LTC2260-14: SNR vs SENSE, $\mathrm{f}_{\mathrm{IN}}=5 \mathrm{MHz},-1 \mathrm{~dB}$


226114 G35
LTC2259-14: 8k Point FFT, $\mathrm{f}_{\mathrm{IN}}=5 \mathrm{MHz}$ -1dBFS, 80Msps


226114 G43
LTC2259-14: 8k Point FFT, $f_{I N}=140 \mathrm{MHz}$ -1dBFS, 80Msps


LTC2259-14: Integral Non-Linearity (INL)


226114 G41
LTC2259-14: 8k Point FFT, $\mathrm{f}_{\mathrm{IN}}=30 \mathrm{MHz}$ -1dBFS, 80Msps


226114 G44
LTC2259-14: 8k Point 2-Tone FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}, 75 \mathrm{MHz},-1 \mathrm{dBFS}$, 80Msps


LTC2259-14: Differential Non-Linearity (DNL)


LTC2259-14: 8k Point FFT, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ -1dBFS, 80Msps


226114 G45
LTC2259-14: Shorted Input Histogram


## TYPICAL PERFORMANCE CHARACTERISTICS

LTC2259-14: SNR vs Input Frequency, -1dB, 2V Range, 80Msps


226114 G49

LTC2259-14: Ivod vs Sample Rate, 5MHz Sine Wave Input, -1dB


LTC2259-14: SFDR vs Input
Frequency, -1dB, 2V Range, 80Msps


226114 G50
LTC2259-14: I Iovdd vs Sample Rate, 5 MHz Sine Wave Input, -1dB, 5pF on Each Data Output


226114 G54

LTC2259-14: SFDR vs Input Level, $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$, 2V Range, 80Msps


LTC2259-14: SNR vs SENSE, $\mathrm{f}_{\mathrm{N}}=5 \mathrm{MHz},-1 \mathrm{~dB}$


226114 G55

## PIn fUnCTIOnS

## PINS THAT ARE THE SAME FOR ALL DIGITAL OUTPUT MODES

$\mathrm{A}_{\mathrm{N}}{ }^{+}(\operatorname{Pin} 1)$ : Positive Differential Analog Input.
$\mathrm{A}_{\mathbf{I N}}{ }^{-}$(Pin 2): Negative Differential Analog Input.
GND (Pin 3): ADC Power Ground.
REFH (Pins 4, 5): ADC High Reference. Bypass to Pins 6,7 with a $2.2 \mu \mathrm{~F}$ ceramic capacitor and to ground with a $0.1 \mu \mathrm{~F}$ ceramic capacitor.

REFL (Pins 6, 7): ADC Low Reference. Bypass to Pins 4,5 with a $2.2 \mu \mathrm{~F}$ ceramic capacitor and to ground with a $0.1 \mu \mathrm{~F}$ ceramic capacitor.
PAR/SER (Pin 8): Programming Mode Selection Pin. Connect to ground to enable the serial programming mode. $\overline{\mathrm{CS}}, \mathrm{SCK}, \mathrm{SDI}, \mathrm{SDO}$ become a serial interface that control the $A / D$ operating modes. Connect to $V_{D D}$ to enable the parallel programming mode where $\overline{\mathrm{C}}$, SCK, SDI become parallel logic inputs that control a reduced set of the A/D operating modes. PAR/SER should be connected directly to ground or the $\mathrm{V}_{\mathrm{DD}}$ of the part and not be driven by a logic signal.
$\mathbf{V}_{D D}$ (Pins 9, 10, 40): 1.8V Analog Power Supply. Bypass to ground with $0.1 \mu \mathrm{~F}$ ceramic capacitors. Pins 9 and 10 can share a bypass capacitor.
ENC ${ }^{+}$(Pin 11): Encode Input. Conversion starts on the rising edge.
ENC- (Pin 12): Encode Complement Input. Conversion starts on the falling edge.
$\overline{\mathrm{CS}}$ (Pin 13): In serial programming mode, (PAR/ $\overline{\mathrm{SER}}=$ 0 V ), $\overline{\mathrm{CS}}$ is the serial interface chip select input. When $\overline{\mathrm{CS}}$ is low, SCK is enabled for shifting data on SDI into the mode control registers. In the parallel programming mode (PAR/ $\left.\overline{S E R}=V_{D D}\right), \overline{C S}$ controls the clock duty cycle stabilizer. When $\overline{\mathrm{CS}}$ is low, the clock duty cycle stabilizer is turned off. When $\overline{\mathrm{CS}}$ is high, the clock duty cycle stabilizer is turned on. $\overline{\mathrm{CS}}$ can be driven with 1.8 V to 3.3 V logic.

SCK (Pin 14): In serial programming mode, (PAR/ $\overline{\text { SER }}=$ OV), SCK is the serial interface clock input. In the parallel programming mode (PAR/SER = VDD), SCK controls the digital output mode. When SCK is low, the full-rate CMOS output mode is enabled. When SCK is high, the doubledata rate LVDS output mode (with 3.5 mA output current) is enabled. SCK can be driven with 1.8 V to 3.3 V logic.
SDI (Pin 15): In serial programming mode, (PAR/ $\overline{\mathrm{SER}}=$ $0 \mathrm{~V}), \mathrm{SDI}$ is the serial interface data input. Data on SDI is clocked into the mode control registers on the rising edge of SCK. In the parallel programming mode (PAR/SER = $V_{D D}$, SDI can be used to power down the part. When SDI is low, the part operates normally. When SDI is high, the part enters sleep mode. SDI can be driven with 1.8 V to 3.3V logic.

SDO (Pin 16): In serial programming mode, (PAR/ $\overline{\mathrm{SER}}$ $=0 \mathrm{~V}$ ), SDO is the optional serial interface data output. Data on SDO is read back from the mode control registers and can be latched on the falling edge of SCK. SDO is an open-drain NMOS output that requires an external $2 k$ pull-up resistor to $1.8 \mathrm{~V}-3.3 \mathrm{~V}$. If read back from the mode control registers is not needed, the pull-up resistor is not necessary and SDO can be left unconnected. In the parallel programming mode (PAR/ $\overline{\mathrm{SER}}=\mathrm{V}_{\mathrm{DD}}$ ), SDO is not used and should not be connected.
OGND (Pin 25): Output Driver Ground.
OV ${ }_{\text {DD }}$ (Pin 26): Output Driver Supply. Bypass to ground with a $0.1 \mu \mathrm{~F}$ ceramic capacitor.
$\mathbf{V}_{\text {CM }}$ (Pin 37): Common Mode Bias Output, Nominally Equal to $\mathrm{V}_{\mathrm{DD}} / 2$. $\mathrm{V}_{\mathrm{CM}}$ should be used to bias the common mode of the analog inputs. Bypass to ground with a $0.1 \mu \mathrm{~F}$ ceramic capacitor.
$\mathbf{V}_{\text {REF }}$ (Pin 38): Reference Voltage Output. Bypass to ground with a $1 \mu \mathrm{~F}$ ceramic capacitor, nominally 1.25 V .

SENSE (Pin 39): Reference Programming Pin. Connecting SENSE to $V_{D D}$ selects the internal reference and $a \pm 1 \mathrm{~V}$ input range. Connecting SENSE to ground selects the internal reference and a $\pm 0.5 \mathrm{~V}$ input range. An external reference between 0.625 V and 1.3 V applied to SENSE selects an input range of $\pm 0.8 \bullet \vee_{\text {SENSE }}$.

## PIn functions

FULL-RATE CMOS OUTPUT MODE
All Pins Below Have CMOS Output Levels (OGND to OV ${ }_{D D}$ )
D0 to D13 (Pins 17-24, 29-34): Digital Outputs. D13 is the MSB.

CLKOUT- (Pin 27): Inverted Version of CLKOUT ${ }^{+}$.
CLKOUT ${ }^{+}$(Pin 28): Data Output Clock. The digital outputs normally transition at the same time as the falling edge of CLKOUT+ ${ }^{+}$. The phase of CLKOUT ${ }^{+}$can also be delayed relative to the digital outputs by programming the mode control registers.

DNC (Pin 35): Do not connect this pin.
OF (Pin 36): Over/Under Flow Digital Output. OF is high when an overflow or underflow has occurred.

## DOUBLE-DATA RATE CMOS OUTPUT MODE

All Pins Below Have CMOS Output Levels (OGND to OV ${ }_{D D}$ )
DO_1 to D12_13 (Pins 18, 20, 22, 24, 30, 32, 34): DoubleData Rate Digital Outputs. Two data bits are multiplexed onto each output pin. The even data bits (D0, D2, D4, D6, D8, D10, D12) appear when CLKOUT+ is low. The odd data bits (D1, D3, D5, D7, D9, D11, D13) appear when CLKOUT+ is high.

CLKOUT${ }^{-}$(Pin 27): Inverted Version of CLKOUT ${ }^{+}$.

CLKOUT ${ }^{+}$(Pin 28): Data Output Clock. The digital outputs normally transition at the same time as the falling and rising edges of CLKOUT ${ }^{+}$. The phase of CLKOUT ${ }^{+}$can also be delayed relative to the digital outputs by programming the mode control registers.
DNC (Pins 17, 19, 21, 23, 29, 31, 33, 35): Do not connect these pins.

OF (Pin 36): Over/Under Flow Digital Output. OF is high when an overflow or underflow has occurred.

## DOUBLE-DATA RATE LVDS OUTPUT MODE

All Pins Below Have LVDS Output Levels. The Output Current Level is Programmable. There is an Optional Internal 100 Termination Resistor Between the Pins of Each LVDS Output Pair.
D0_1-/D0_1+ to D12_13/D12_13+ (Pins 17/18, 19/20, 21/22, 23/24, 29/30, 31/32, 33/34): Double-Data Rate Digital Outputs. Two data bits are multiplexed onto each differential output pair. The even data bits (D0, D2, D4, D6, D8, D10, D12) appear when CLKOUT+ is low. The odd data bits (D1, D3, D5, D7, D9, D11, D13) appear when CLKOUT+ is high.
CLKOUT-/CLKOUT+ (Pins 27/28): Data Output Clock. The digital outputs normally transition at the same time as the falling and rising edges of CLKOUT ${ }^{+}$. The phase of CLKOUT ${ }^{+}$can also be delayed relative to the digital outputs by programming the mode control registers.
OF-/0F+ (Pins 35/36): Over/Under Flow Digital Output. $0 \mathrm{~F}^{+}$is high when an overflow or underflow has occurred.

## fUnCTIOnAL BLOCK DIAGRAM



Figure 1. Functional Block Diagram

## APPLICATIONS INFORMATION

## CONVERTER OPERATION

The LTC2261-14/LTC2260-14/LTC2259-14 are low power 14-bit 125Msps/105Msps/80Msps A/D converters that are powered by a single 1.8 V supply. The analog inputs should be driven differentially. The encode input can be driven differentially, or single ended for lower power consumption. The digital outputs can be CMOS, double-data rate CMOS (to halve the number of output lines), or double-data rate LVDS (to reduce digital noise in the system.) Many additional features can be chosen by programming the mode control registers through a serial SPI port. See the Serial Programming Mode section.

## ANALOG INPUT

The analog input is a differential CMOS sample-and-hold circuit (Figure 2). The inputs should be driven differentially around a common mode voltage set by the $\mathrm{V}_{\mathrm{CM}}$ output pin, which is nominally $\mathrm{V}_{\mathrm{DD}} / 2$. For the 2 V input range,


Figure 2. Equivalent Input Circuit
the inputs should swing from $\mathrm{V}_{\mathrm{CM}}-0.5 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CM}}+0.5 \mathrm{~V}$. There should be $180^{\circ}$ phase difference between the inputs.

## INPUT DRIVE CIRCUITS

## Input Filtering

If possible, there should be an RC lowpass filter right at the analog inputs. This lowpass filter isolates the drive circuitry from the $A / D$ sample-and-hold switching, and alsolimits wideband noise from the drive circuitry. Figure 3 shows an example of an input RC filter. The RC component values should be chosen based on the application's input frequency.

## Transformer-Coupled Circuits

Figure 3 shows the analog input being driven by an RF transformer with a center-tapped secondary. The center tap is biased with $V_{C M}$, setting the $A / D$ input at its optimal


Figure 3. Analog Input Circuit Using a Transformer.
Recommended for Input Frequencies from 5 MHz to 70 MHz

## APPLICATIONS INFORMATION

DC level. At higher input frequencies a transmission line balun transformer (Figures 4 to 6) has better balance, resulting in lower A/D distortion.

## Amplifier Circuits

Figure 7 shows the analog input being driven by a high speed differential amplifier. The output of the amplifier is AC-coupled to the A/D so the amplifier's output common mode voltage can be optimally set to minimize distortion.


T1: MA/COM MABA-007159-000000
T2: MA/COM MABAESOO6O
RESISTORS, CAPACITORS ARE 0402 PACKAGE SIZE
Figure 4. Recommended Front-End Circuit for Input Frequencies from 70MHz to 170MHz

At very high frequencies an RF gain block will often have lower distortion than a differential amplifier. If the gain block is single-ended, then atransformer circuit (Figures 4 to 6) should convert the signal to differential before driving the $A / D$.


T1: MA/COM MABA-007159-000000
T2: COILCRAFT WBC1-1LB
RESISTORS, CAPACITORS ARE 0402 PACKAGE SIZE

Figure 5. Recommended Front-End Circuit for Input Frequencies from 170 MHz to 270 MHz


Figure 6. Recommended Front-End Circuit for Input Frequencies Above 270MHz

## APPLICATIONS InFORMATION

Reference
The LTC2261-14/LTC2260-14/LTC2259-14 have an internal 1.25 V voltage reference. For a 2 V input range using the internal reference, connect SENSE to $V_{D D}$. For a 1 V input range using the internal reference, connect SENSE to ground. For a 2 V input range with an external reference, apply a 1.25 V reference voltage to SENSE (Figure 9.)

The input range can be adjusted by applying a voltage to SENSE that is between 0.625 V and 1.30 V . The input range will then be $1.6 \bullet{ }^{\text {SENSE. }}$


Figure 7. Front-End Circuit Using a High Speed Differential Amplifier

The $V_{\text {REF }}$, REFH and REFL pins should be bypassed as shown in Figure 8. The $0.1 \mu \mathrm{~F}$ capacitor between REFH and REFL should be as close to the pins as possible (not on the back side of the circuit board).


Figure 8. Reference Circuit


Figure 9. Using an External 1.25V Reference

## APPLICATIONS INFORMATION

## Encode Input

The signal quality of the encode inputs strongly affects the $A / D$ noise performance. The encode inputs should be treated as analog signals-do not route them next to digital traces on the circuit board. There are two modes of operation for the encode inputs: the differential encode mode (Figure 10) and the single-ended encode mode (Figure 11).

The differential encode mode is recommended for sinusoidal, PECL or LVDS encode inputs (Figures 12, 13). The encode inputs are internally biased to 1.2 V through 10k equivalent resistance. The encode inputs can be taken above $V_{D D}$ (up to 3.6 V ), and the common mode range is from 1.1 V to 1.6 V . In the differential encode mode, ENC ${ }^{-}$should stay at least 200 mV above ground to avoid falsely triggering the single-ended encode mode. For good jitter performance ENC ${ }^{+}$and ENC ${ }^{-}$should have fast rise and fall times.

The single-ended encode mode should be used withCMOS encode inputs. To select this mode, ENC ${ }^{-}$is connected to ground and ENC ${ }^{+}$is driven with a square wave encode input. ENC ${ }^{+}$can be taken above $V_{D D}$ (up to 3.6 V ) so 1.8 V to 3.3V CMOS logic levels can be used. The ENC ${ }^{+}$threshold is 0.9 V . For good jitter performance ENC ${ }^{+}$should have fast rise and fall times.

## Clock Duty Cycle Stabilizer

For good performance the encode signal should have a $50 \%( \pm 5 \%)$ duty cycle. If the optional clock duty cycle stabilizer circuit is enabled, the encode duty cycle can vary from $30 \%$ to $70 \%$ and the duty cycle stabilizer will maintain a constant $50 \%$ internal duty cycle. If the encode signal changes frequency or is turned off, the duty cycle stabilizer circuit requires one hundred clock cycles to lock onto the input clock. The duty cycle stabilizer is enabled by mode control register A2 (serial programming mode), or by $\overline{\mathrm{CS}}$ (parallel programming mode).


T1: COILCRAFT WBC4-1WL
D1: AVAGO HSMS - 2822
RESISTORS, CAPACITORS ARE 0402 PACKAGE SIZE

Figure 12. Sinusoidal Encode Drive
Figure 10. Equivalent Encode Input Circuit for Differential Encode Mode


Figure 11. Equivalent Encode Input Circuit for Single-Ended Encode Mode


Figure 13. PECL or LVDS Encode Drive

## APPLICATIONS InFORMATION

For applications where the sample rate needs to be changed quickly, the clock duty cycle stabilizer can be disabled. If the duty cycle stabilizer is disabled, care should be taken to make the sampling clock have a $50 \%( \pm 5 \%)$ duty cycle. The duty cycle stabilizer should not be used below 5Msps.

## DIGITAL OUTPUTS

## Digital Output Modes

The LTC2261-14/LTC2260-14/LTC2259-14 can operate in three digital output modes: full-rate CMOS, doubledata rate CMOS (to halve the number of output lines), or double-data rate LVDS (to reduce digital noise in the system). The output mode is set by mode control register A3 (serial programming mode), or by SCK (parallel programming mode). Note that double-data rate CMOS cannot be selected in the parallel programming mode.

## Full-Rate CMOS Mode

In full-rate CMOS mode the 14 digital outputs (D0-D13), overflow (OF), and the data output clocks (CLKOUT+, CLKOUT-) have CMOS output levels. The outputs are powered by OV ${ }_{D D}$ and OGND which are isolated from the $A / D$ core power and ground. $O V_{D D}$ can range from 1.1 V to 1.9 V , allowing 1.2 V through 1.8 V CMOS logic outputs.
For good performance, the digital outputs should drive minimal capacitive loads. If the load capacitance is larger than 10 pF a digital buffer should be used.

## Double-Data Rate CMOS Mode

In double-data rate CMOS mode, two data bits are multiplexed and output on each data pin. This reduces the number of data lines by seven, simplifying board routing and reducing the number of input pins needed to receive the data. The 7 digital outputs (D0_1, D2_3, D4_5, D6_7, D8_9, D10_11, D12_13), overflow (OF), and the data output clocks (CLKOUT+ ${ }^{+}$, CLKOUT $^{-}$) have CMOS output levels. The outputs are powered by $\mathrm{OV}_{\mathrm{DD}}$ and OGND which are isolated from the $A / D$ core power and ground. $O V_{D D}$ can range from 1.1 V to 1.9 V , allowing 1.2 V through 1.8 V CMOS logic outputs.
For good performance the digital outputs should drive minimal capacitive loads. If the load capacitance is larger than 10 pF a digital buffer should be used.

When using double-data rate CMOS at high sample rates the SNR will degrade slightly (see Typical Performance Characteristics section). DDR CMOS is not recommended for sample frequencies above 100 MHz .

## Double-Data Rate LVDS Mode

In double-data rate LVDS mode, two data bits are multiplexed and output on each differential output pair. There are 7 LVDS output pairs (D0_1+/D0_1- through D12_13+/D12_13-) for the digital output data. Overflow ( $\mathrm{OF}^{+} / \mathrm{OF}^{-}$) and the data outputclock (CLKOUT ${ }^{+} / \mathrm{CLKOUT}^{-}$) each have an LVDS output pair.

By default the outputs are standard LVDS levels: 3.5 mA output current and a 1.25 V output common mode voltage. An external $100 \Omega$ differential termination resistor is required for each LVDS output pair. The termination resistors should be located as close as possible to the LVDS receiver.

The outputs are powered by $0 V_{D D}$ and OGND which are isolated from the $A / D$ core power and ground. In LVDS mode, $O V_{D D}$ must be 1.8 V .

## Programmable LVDS Output Current

In LVDS mode, the default output driver current is 3.5 mA . This current can be adjusted by serially programming mode control register A3. Available current levels are 1.75 mA , $2.1 \mathrm{~mA}, 2.5 \mathrm{~mA}, 3 \mathrm{~mA}, 3.5 \mathrm{~mA}, 4 \mathrm{~mA}$ and 4.5 mA .

## Optional LVDS Driver Internal Termination

In most cases using just an external $100 \Omega$ termination resistor will give excellent LVDS signal integrity. In addition, an optional internal $100 \Omega$ termination resistor can be enabled by serially programming mode control register A3. The internal termination helps absorb any reflections caused by imperfect termination at the receiver. When the internal termination is enabled, the output driver current is increased by $1.6 x$ to maintain about the same output voltage swing.

## Overflow Bit

The overflow output bit (OF) outputs a logic high when the analog input is either overranged or underranged. The overflow bit has the same pipeline latency as the data bits.

## APPLICATIONS INFORMATION

## Phase Shifting the Output Clock

In full-rate CMOS mode the data output bits normally change at the same time as the falling edge of CLKOUT ${ }^{+}$, so the rising edge of CLKOUT+ can be used to latch the output data. In double-data rate CMOS and LVDS modes the data output bits normally change at the same time as the falling and rising edges of CLKOUT+ ${ }^{+}$. To allow adequate setup-and-hold time when latching the data, the CLKOUT+ signal may need to be phase shifted relative to the data output bits. Most FPGAs have this feature; this is generally the best place to adjust the timing.
The LTC2261-14/LTC2260-14/LTC2259-14 canalso phase shift the CLKOUT $+/$ CLKOUT- signals by serially programming mode control register A2. The output clock can be shifted by $0^{\circ}, 45^{\circ}, 90^{\circ}$ or $135^{\circ}$. To use the phase shifting feature the clock duty cycle stabilizer must be turned on. Another control register bit can invert the polarity of CLKOUT+ and CLKOUT ${ }^{-}$, independently of the phase shift. The combination of these two features enables phase shifts of $45^{\circ}$ up to $315^{\circ}$ (Figure 14).

## DATA FORMAT

Table 1 shows the relationship between the analog input voltage, the digital data output bits and the overflow bit. By default the output data format is offset binary. The 2's complement format can be selected by serially programming mode control register A4.
Table 1. Output Codes vs Input Voltage

| $A_{I_{N}+}-$ AlN $^{-}$ <br> (2V Range) | OF | D13-DO <br> (OFFSET BINARY) | D13-DO <br> (2's COMPLEMENT) |
| :--- | :---: | :--- | :--- |
| $>1.000000 \mathrm{~V}$ | 1 | 11111111111111 | 01111111111111 |
| +0.999878 V | 0 | 11111111111111 | 01111111111111 |
| +0.999756 V | 0 | 11111111111110 | 01111111111110 |
| +0.000122 V | 0 | 10000000000001 | 00000000000001 |
| +0.000000 V | 0 | 10000000000000 | 00000000000000 |
| -0.000122 V | 0 | 01111111111111 | 11111111111111 |
| -0.000244 V | 0 | 01111111111110 | 11111111111110 |
| -0.999878 V | 0 | 00000000000001 | 10000000000001 |
| -1.000000 V | 0 | 00000000000000 | 10000000000000 |
| $\leq-1.000000 \mathrm{~V}$ | 1 | 00000000000000 | 10000000000000 |



Figure 14. Phase Shifting CLKOUT

## APPLICATIONS InFORMATION

Digital Output Randomizer
Interference from the A/D digital outputs is sometimes unavoidable.Digital interference may be from capacitive or inductive coupling or coupling through the ground plane. Even a tiny coupling factor can cause unwanted tones in the ADC output spectrum. By randomizing the digital output before it is transmitted off chip, these unwanted tones can be randomized which reduces the unwanted tone amplitude.

The digital output is randomized by applying an exclusiveOR logic operation between the LSB and all other data outputbits. To decode, the reverse operation is applied-an exclusive-OR operation is applied between the LSB and all other bits. The LSB, OF and CLKOUT outputs are not affected. The output randomizer is enabled by serially programming mode control register A4.


Figure 15. Functional Equivalent of Digital Output Randomizer

## Alternate Bit Polarity

Another feature that reduces digital feedback on the circuit board is the alternate bit polarity mode. When this mode is enabled, all of the odd bits (D1, D3, D5, D7, D9, D11, D13) are inverted before the output buffers. The even bits (D0, D2, D4, D6, D8, D10, D12), OF and CLK0UT are not affected. This can reduce digital currents in the circuit board ground plane and reduce digital noise, particularly for very small analog input signals.

When there is a very small signal at the input of the $A / D$ that is centered around mid-scale, the digital outputs toggle between mostly 1s and mostly Os. This simultaneous switching of most of the bits will cause large currents in the ground plane. By inverting every other bit, the alternate bit polarity mode makes half of the bits transition high while half of the bits transition low. To first order, this cancels current flow in the ground plane, reducing the digital noise.


Figure 16. Unrandomizing a Randomized Digital Output Signal

## APPLICATIONS INFORMATION

The digital output is decoded at the receiver by inverting the odd bits (D1, D3, D5, D7, D9, D11, D13.) The alternate bit polarity mode is independent of the digital output randomizer-either, both or neither function can be on at the same time. When alternate bit polarity mode is on, the data format is offset binary and the 2's complement control bit has no effect. The alternate bit polarity mode is enabled by serially programming mode control registerA4.

## Digital Output Test Patterns

To allow in-circuit testing of the digital interface to the $A / D$, there are several test modes that force the $A / D$ data outputs (OF, D13-D0) to known values:

## All 1s: All outputs are 1

All Os: All outputs are 0
Alternating: Outputs change from all 1 s to all 0 s on alternating samples

Checkerboard: Outputs change from 101010101010101 to 010101010101010 on alternating samples
The digital output test patterns are enabled by serially programming mode control register A4. When enabled, the test patterns override all other formatting modes: 2's complement, randomizer, alternate-bit-polarity.

## Output Disable

The digital outputs may be disabled by serially programming mode control register A3. All digital outputs including OFand CLKOUTare disabled. The high impedance disabled state is intended for long periods of inactivity-it is too slow to multiplex a data bus between multiple converters at full speed.

## Sleep and Nap Modes

The A/D may be placed in sleep or nap modes to conserve power. In sleep mode the entire A/D converter is powered down, resulting in 0.5 mW powerconsumption. Sleep mode is enabled by mode control register A1 (serial programming mode), or by SDI (parallel programming mode). The amount of time required to recover from sleep mode depends on the size of the bypass capacitors on $V_{\text {REF }}$,

REFH, and REFL. For the suggested values in Figure 8, the $A / D$ will stabilize after 2 ms .

In nap mode the $A / D$ core is powered down while the internal reference circuits stay active, allowing faster wake-up than from sleep mode. Recovering from nap mode requires at least 100 clock cycles. If the application demands very accurate DC settling then an additional $50 \mu \mathrm{~s}$ should be allowed so the on-chip references can settle from the slight temperature shift caused by the change in supply current as the A/D leaves nap mode. Nap mode is enabled by mode control register A1 in the serial programming mode.

## DEVICE PROGRAMMING MODES

The operating modes of the LTC2261-14 can be programmed by either a parallel interface or a simple serial interface. The serial interface has more flexibility and can program all available modes. The parallel interface is more limited and can only program some of the more commonly used modes.

## Parallel Programming Mode

To use the parallel programming mode, PAR/ $\overline{\mathrm{SER}}$ should be tied to $\mathrm{V}_{\mathrm{DD}}$. The $\overline{\mathrm{CS}}, \mathrm{SCK}$ and SDI pins are binary logic inputs that set certain operating modes. These pins can be tied to $\mathrm{V}_{\mathrm{DD}}$ or ground, or driven by $1.8 \mathrm{~V}, 2.5 \mathrm{~V}$ or 3.3 V CMOS logic. Table 2 shows the modes set by $\overline{C S}$, SCK and SDI.

Table 2. Parallel Programming Mode Control Bits $\left(\mathrm{PAR} / \overline{\mathrm{SER}}=\mathrm{V}_{\mathrm{DD}}\right)$

| PIN | DESCRIPTION |
| :--- | :--- |
| $\overline{\text { CS }}$ | Clock Duty Cycle Stabilizer Control Bit |
|  | $0=$ Clock Duty Cycle Stabilizer Off |
|  | $1=$ Clock Duty Cycle Stabilizer On |
| SCK | Digital Output Mode Control Bit |
|  | $0=$ Full-Rate CMOS Output Mode |
|  | $1=$ Double-Data Rate LVDS Output Mode |
|  | $\quad$(3.5mA LVDS Current, Internal Termination Offi) |
| SDI | Power Down Control Bit |
|  | $0=$ Normal Operation |
|  | $1=$ Sleep Mode |

## APPLICATIONS INFORMATION

## Serial Programming Mode

To use the serial programming mode, PAR/ $\overline{\mathrm{SER}}$ should be tied to ground. The $\overline{\mathrm{CS}}, \mathrm{SCK}, \mathrm{SDI}$ and SDO pins become a serial interface that program the A/D mode control registers. Data is written to a register with a 16-bit serial word. Data can also be read back from a register to verify its contents.
Serial data transfer starts when $\overline{\mathrm{CS}}$ is taken low. The data on the SDI pin is latched at the first 16 rising edges of SCK. Any SCK rising edges after the first 16 are ignored. The data transfer ends when $\overline{\mathrm{CS}}$ is taken high again.
The first bit of the 16 -bit input word is the $R / \bar{W}$ bit. The next seven bits are the address of the register (A6:A0). The final eight bits are the register data (D7:D0).
If the $R / \bar{W}$ bit is low, the serial data ( $D 7: D 0$ ) will be written to the register set by the address bits (A6:AO). If the $\mathrm{R} / \overline{\mathrm{W}}$ bit is high, data in the register set by the address bits (A6:AO) will be read back on the SDO pin (see the timing diagrams). During a read back command the register is not updated and data on SDI is ignored.

The SDO pin is an open-drain output that pulls to ground with a $200 \Omega$ impedance. If register data is read back through SDO, an external $2 k$ pull-up resistor is required. If serial data is only written and read back is not needed, then SDO can be left floating and no pull-up resistor is needed.
Table 3 shows a map of the mode control registers.

## Software Reset

If serial programming is used, the mode control registers should be programmed as soon as possible after the power supplies turn on and are stable. The first serial command must be a software reset which will reset all register data bits to logic 0 . To perform a software reset, bit D7 in the reset register is written with a logic 1 . After the reset SPI write command is complete, bit D7 is automatically set back to zero.

Table 3. Serial Programming Mode Register Map
REGISTER AO: RESET REGISTER (ADDRESS OOh)


REGISTER A1: POWER-DOWN REGISTER (ADDRESS 01h)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X | X | X | X | X | X | PWROFF1 | PWROFF0 |

Bits 7-2 Unused, Don't Care Bits.

Bits 1-0 PWROFF1:PWROFFO Power Down Control Bits
$00=$ Normal Operation
01 = Nap Mode
10 = Not Used
11 = Sleep Mode

## APPLICATIONS INFORMATION

REGISTER A2: TIMING REGISTER (ADDRESS 02h)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X | X | X | X | CLKINV | CLKPHASE1 | CLKPHASE0 | DCS |

Bits 7-4 Unused, Don't Care Bits.

Bit 3 CLKINV Output Clock Invert Bit
$0=$ Normal CLKOUT Polarity (As Shown in the Timing Diagrams)
1 = Inverted CLKOUT Polarity
Bits 2-1 CLKPHASE1:CLKPHASEO Output Clock Phase Delay Bits
$00=$ No CLKOUT Delay (As Shown in the Timing Diagrams)
$01=$ CLKOUT $^{+} /$CLKOUT ${ }^{-}$Delayed by $45^{\circ}$ (Clock Period • 1/8)
$10=$ CLKOUT $^{+} /$CLKOUT ${ }^{-}$Delayed by $90^{\circ}$ (Clock Period • 1/4)
$11=$ CLKOUT $^{+} /$CLKOUT $^{-}$Delayed by $135^{\circ}$ (Clock Period •3/8)
Note: If the CLKOUT Phase Delay Feature is Used, the Clock Duty Cycle Stabilizer Must Also be Turned On
Bit $0 \quad$ DCS Clock Duty Cycle Stabilizer Bit
0 = Clock Duty Cycle Stabilizer Off
1 = Clock Duty Cycle Stabilizer On
REGISTER A3: OUTPUT MODE REGISTER (ADDRESS 03h)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X | ILVDS2 | ILVDS1 | ILVDSO | TERMON | OUTOFF | OUTMODE1 | OUTMODEO |
| Bit 7 | Unused, Don't Care Bit. |  |  |  |  |  |  |
| Bits 6-4 | ILVDS2:ILVDSO LVDS Output Current Bits $000=3.5 \mathrm{~mA}$ LVDS Output Driver Current $001=4.0 \mathrm{~mA}$ LVDS Output Driver Current $010=4.5 \mathrm{~mA}$ LVDS Output Driver Current $011=$ Not Used <br> $100=3.0 \mathrm{~mA}$ LVDS Output Driver Current $101=2.5 \mathrm{~mA}$ LVDS Output Driver Current $110=2.1 \mathrm{~mA}$ LVDS Output Driver Current <br> $111=1.75 \mathrm{~mA}$ LVDS Output Driver Current |  |  |  |  |  |  |
| Bit 3 | TERMON LVDS Internal Termination Bit <br> 0 = Internal Termination Off <br> 1 = Internal Termination On. LVDS Output Driver Current is $1.6 \times$ the Current Set by ILVDS2:ILVDSO |  |  |  |  |  |  |
| Bit 2 | OUTOFF Output Disable Bit$0=$ Digital Outputs are Enabled$1=$ Digital Outputs are Disabled and Have High Output Impedance |  |  |  |  |  |  |
| Bits 1-0 | OUTMODE1:OUTMODEO Digital Output Mode Control Bits $00=$ Full-Rate CMOS Output Mode <br> 01 = Double-Data Rate LVDS Output Mode <br> $10=$ Double-Data Rate CMOS Output Mode <br> 11 = Not Used |  |  |  |  |  |  |

## APPLICATIONS INFORMATION

register a4: data format register (AdDress 04h)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X | X | OUTTEST2 | OUTTEST1 | OUTTESTO | ABP | RAND | TWOSCOMP |
| Bit 7-6 | Unused, Don't Care Bits. |  |  |  |  |  |  |
| Bits 5-3 | OUTTEST2:OUTTESTO <br> Digital Output Test Pattern Bits <br> $000=$ Digital Output Test Patterns Off <br> 001 = All Digital Outputs $=0$ <br> 011 = All Digital Outputs $=1$ <br> 101 = Checkerboard Output Pattern. OF, D13-D0 Alternate Between 101010101010101 and 010101010101010 <br> 111 = Alternating Output Pattern. OF, D13-D0 Alternate Between 000000000000000 and 111111111111111 <br> Note: Other Bit Combinations are not Used |  |  |  |  |  |  |
| Bit 2 | ABP <br> Alternate Bit Polarity Mode Control Bit <br> 0 = Alternate Bit Polarity Mode Off <br> 1 = Alternate Bit Polarity Mode On |  |  |  |  |  |  |
| Bit 1 | RAND <br> Data Output Randomizer Mode Control Bit <br> 0 = Data Output Randomizer Mode Off <br> 1 = Data Output Randomizer Mode On |  |  |  |  |  |  |
| Bit 0 | TWOSCOMP Two's Complement Mode Control Bit $0=$ Offset Binary Data Format 1 = Two's Complement Data Format Note: ABP = 1 Forces the Output Format to be Offset Binary |  |  |  |  |  |  |

## GROUNDING AND BYPASSING

The LTC2261-14 requires a printed circuit board with a clean unbroken ground plane. A multilayer board with an internal ground plane is recommended. Layout for the printed circuit board should ensure that digital and analog signal lines are separated as much as possible. In particular, care should be taken not to run any digital track alongside an analog signal track or underneath the ADC.
High quality ceramic bypass capacitors should be used at the $\mathrm{V}_{\mathrm{DD}}, \mathrm{O}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{CM}}, \mathrm{V}_{\mathrm{REF}}$, REFH and REFL pins. Bypass capacitors must be located as close to the pins as possible. Of particular importance is the $0.1 \mu \mathrm{~F}$ capacitor between REFH and REFL. This capacitor should be on the same side of the circuit board as the A/D, and as close to the device as possible ( 1.5 mm or less). Size 0402 ceramic capacitors are recommended. The larger $2.2 \mu \mathrm{~F}$ capacitor between REFH and REFL can be somewhat further away.

The $V_{\text {CM }}$ capacitor should be located as close to the pin as possible. To make space for this the capacitor on $V_{\text {REF }}$ can be further away or on the back of the PC board. The traces connecting the pins and bypass capacitors must be kept short and should be made as wide as possible.

The analog inputs, encode signals, and digital outputs should not be routed next to each other. Ground fill and grounded vias should be used as barriers to isolate these signals from each other.

## HEAT TRANSFER

Most of the heat generated by the LTC2261-14 is transferred from the die through the bottom-side exposed pad and package leads onto the printed circuit board. For good electrical and thermal performance, the exposed pad must be soldered to a large grounded pad on the PC board.

## TYPICAL APPLICATIONS

## LTC2261 Schematic



LTC2261-14
LTC2260-14/LTC2259-14

## TYPICAL APPLICATIONS

Silkscreen Top


Top Side


226114 TA04

Inner Layer 2 GND


Inner Layer 3


## TYPICAL APPLICATIONS



Inner Layer 5 Power


Bottom Side


## PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.
UJ Package
40-Lead Plastic QFN ( $6 \mathrm{~mm} \times 6 \mathrm{~mm}$ )
(Reference LTC DWG \# 05-08-1728 Rev Ø)


RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED


## REVISION HISTORY (Revision history begins at Rev B )

| REV | DATE | DESCRIPTION | PAGE NUMBER |
| :---: | :---: | :--- | :---: |
| B | $08 / 12$ | Corrected IOVDD to IOVDD. | 14 |
|  |  | Corrected RESET REGISTER A0, D7 description. <br> Attached VDD to pins 9,10 and 40 on schematic. | 26 |
|  |  | 29 |  |
| C | $01 / 14$ | Corrected "external reference" to "internal reference" for 1V input range. | 20 |

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## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| LT1993-2 | High Speed Differential Op Amp | 800MHz BW, 70dBc Distortion at 70MHz, 6dB Gain |
| LT1994 | Low Noise, Low Distortion Fully Differential Input/ Output Amplifier/Driver | Low Distortion: -94dBc at 1MHz |
| LTC2215 | 16-Bit, 65Msps, Low Noise ADC | 700mW, 81.5dB SNR, 100dB SFDR, 64-Pin QFN |
| LTC2216 | 16-Bit, 80Msps, Low Noise ADC | 970mW, 81.3dB SNR, 100dB SFDR, 64-Pin QFN |
| LTC2217 | 16-Bit, 105Msps, Low Noise ADC | $1190 \mathrm{~mW}, 81.2 \mathrm{~dB}$ SNR, 100dB SFDR, 64-Pin QFN |
| LTC2202 | 16-Bit, 10Msps, 3.3V ADC, Lowest Noise | $140 \mathrm{~mW}, 81.6 \mathrm{~dB} \mathrm{SNR}$, 100dB SFDR, 48-Pin QFN |
| LTC2203 | 16-Bit, 25Msps, 3.3V ADC, Lowest Noise | $220 \mathrm{~mW}, 81.6 \mathrm{~dB}$ SNR, 100dB SFDR, 48-Pin QFN |
| LTC2204 | 16-Bit, 40Msps, 3.3V ADC | 480mW, 79dB SNR, 100dB SFDR, 48-Pin QFN |
| LTC2205 | 16-Bit, 65Msps, 3.3V ADC | $590 \mathrm{~mW}, 79 \mathrm{~dB}$ SNR, 100dB SFDR, 48-Pin QFN |
| LTC2206 | 16-Bit, 80Msps, 3.3V ADC | $725 \mathrm{~mW}, 77.9 \mathrm{~dB}$ SNR, 100dB SFDR, 48-Pin QFN |
| LTC2207 | 16-Bit, 105Msps, 3.3V ADC | $900 \mathrm{~mW}, 77.9 \mathrm{~dB}$ SNR, 100dB SFDR, 48-Pin QFN |
| LTC2208 | 16-Bit, 130Msps, 3.3V ADC, LVDS Outputs | $1250 \mathrm{~mW}, 77.7 \mathrm{~dB}$ SNR, 100dB SFDR, 64-Pin QFN |
| LTC2209 | 16-Bit, 160Msps, 3.3V ADC, LVDS Outputs | $1450 \mathrm{~mW}, 77.1 \mathrm{~dB}$ SNR, 100dB SFDR, 64-Pin QFN |
| LTC2220 | 12-Bit, 170Msps ADC | $890 \mathrm{~mW}, 67.5 \mathrm{~dB} \mathrm{SNR}, 9 \mathrm{~mm} \times 9 \mathrm{~mm}$ QFN Package |
| LTC2220-1 | 12-Bit, 185Msps, 3.3V ADC, LVDS Outputs | 910mW, 67.7dB SNR, 80dB SFDR, 64-Pin QFN |
| LTC2224 | 12-Bit, 135Msps, 3.3V ADC, High IF Sampling | 630mW, 67.6dB SNR, 84dB SFDR, 48-Pin QFN |
| LTC2249 | 14-Bit, 80Msps ADC | $230 \mathrm{~mW}, 73 \mathrm{~dB}$ SNR, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LTC2250 | 10-Bit, 105Msps ADC | $320 \mathrm{~mW}, 61.6 \mathrm{~dB} \mathrm{SNR}, 5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LTC2251 | 10-Bit, 125Msps ADC | $395 \mathrm{~mW}, 61.6 \mathrm{~dB}$ SNR, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LTC2252 | 12-Bit, 105Msps ADC | $320 \mathrm{~mW}, 70.2 \mathrm{~dB}$ SNR, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LTC2253 | 12-Bit, 125Msps ADC | $395 \mathrm{~mW}, 70.2 \mathrm{~dB}$ SNR, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LTC2254 | 14-Bit, 105Msps ADC | $320 \mathrm{~mW}, 72.5 \mathrm{~dB}$ SNR, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LTC2255 | 14-Bit, 125Msps, 3V ADC, Lowest Power | $395 \mathrm{~mW}, 72.5 \mathrm{~dB}$ SNR, 88dB SFDR, 32-Pin QFN |
| $\begin{aligned} & \text { LTC2259-12/ } \\ & \text { LTC2260-12/ } \\ & \text { LTC2261-12 } \end{aligned}$ | 12-Bit, 80/105/125Msps 1.8V ADCs, Ultralow Power | 87mW/103mW/124mW, 70.8dB SNR, 85dB SFDR, DDR LVDS/DDR CMOS/ CMOS Outputs, $6 \mathrm{~mm} \times 6 \mathrm{~mm}$ QFN Package |
| LTC2284 | 14-Bit, Dual, 105Msps, 3V ADC, Low Crosstalk | $540 \mathrm{~mW}, 72.4 \mathrm{~dB}$ SNR, 88dB SFDR, 64-Pin QFN |
| LTC2299 | Dual 14-Bit, 80Msps ADC | $230 \mathrm{~mW}, 71.6 \mathrm{~dB}$ SNR, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ QFN Package |
| LT5517 | 40MHz to 900MHz Direct Conversion Quadrature Demodulator | High IIP3: 21 dBm at 800 MHz , Integrated LO Quadrature Generator |
| LT5527 | 400MHz to 3.7GHz High Linearity Downconverting Mixer | 24.5 dBm IIP3 at 900 MHz , 23.5 dBm IIP3 at 3.5 GHz , NF $=12.5 \mathrm{~dB}$, $50 \Omega$ Single-Ended RF and LO Ports |
| LT5557 | 400MHz to 3.8 GHz High Linearity Downconverting Mixer | 23.7 dBm IIP3 at $2.6 \mathrm{GHz}, 23.5 \mathrm{dBm}$ IIP3 at 3.5 GHz , $\mathrm{NF}=13.2 \mathrm{~dB}$, 3.3V Supply Operation, Integrated Transformer |
| LT5575 | 800 MHz to 2.7 GHz Direct Conversion Quadrature Demodulator | High IIP3: 28dBm at 900MHz, Integrated LO Quadrature Generator Integrated RF and LO Transformer |
| LTC6400-20 | 1.8GHz Low Noise, Low Distortion Differential ADC Driver for 300MHz IF | Fixed Gain $10 \mathrm{~V} / \mathrm{N}, 2.1 \mathrm{nV} \sqrt{\mathrm{Hz}}$ Total Input Noise, 3mm $\times 3 \mathrm{~mm}$ QFN-16 Package |
| LT6604-2.5/ <br> LT6604-5/ <br> LT6604-10/ <br> LT6604-15 | Dual Matched 2.5MHz, 5MHz, 10MHz, 15MHz Filter with ADC Driver | Dual Matched 4th Order LP Filters with Differential Drivers. Low Noise, Low Distortion Amplifiers |

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